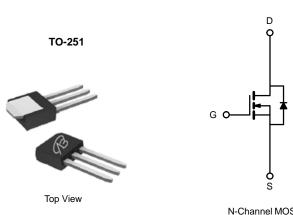


## N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>(BR)DSS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>		
20	$0.005@V_{GS} = 4.5V$	85		
20	0.008@V <sub>GS</sub> = 2.5 V	70		



#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
  Compliant to RoHS Directive 2011/65/EU

#### **APPLICATIONS**

- OR-ing
- Server ٠
- DC/DC •

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = $25^{\circ}$ C UNLESS OTHERWISE NOTED)				
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	20	v
Gate-Source Voltage		V <sub>GS</sub>	±12	v
Continuous Drain Current (T <sub>.1</sub> = 175°C)	$T_{C} = 25^{\circ}C$	I <sub>D</sub>	85	
Continuous Drain Current (13 = 173 C)	T <sub>C</sub> = 100°C		68	A
Pulsed Drain Current		I <sub>DM</sub>	255	
Avalanche Current		I <sub>AR</sub>	35	
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	45	mJ
Power Dissipation	T <sub>C</sub> = 25°C	PD	125 <sup>a</sup>	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) <sup>c</sup>	P	40	°C/W	
Junction-to-Ambient	Free Air (TO-220AB)	R <sub>thJA</sub>	62.5		
Junction-to-Case		R <sub>thJC</sub>	1.25		

Notes:

a. See SOA curve for voltage derating.

b. Duty cycle  $\leq$  1%. c. When mounted on 1" square PCB (FR-4 material).

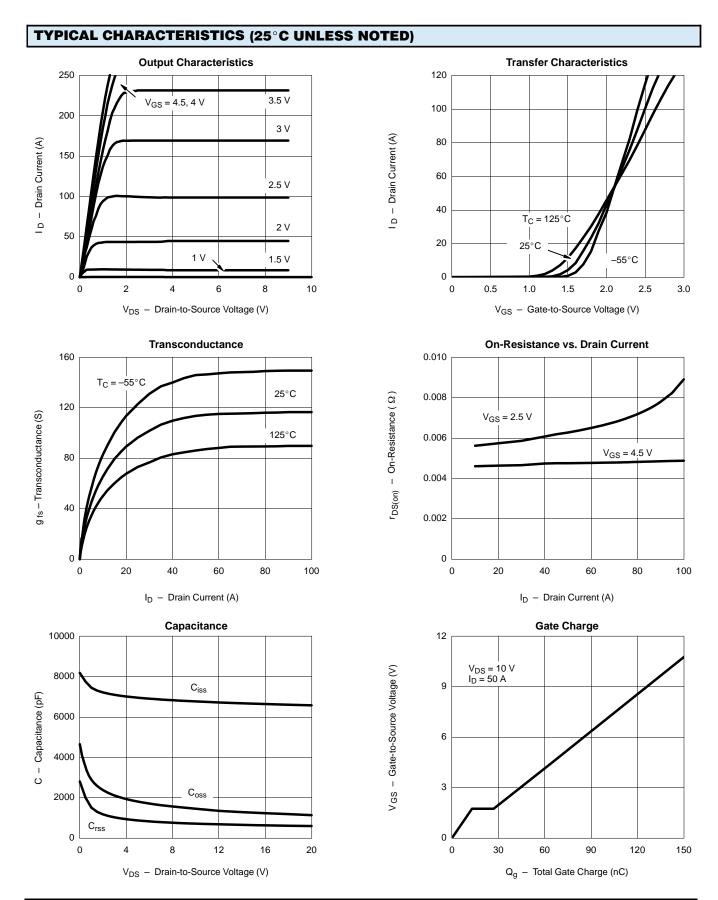
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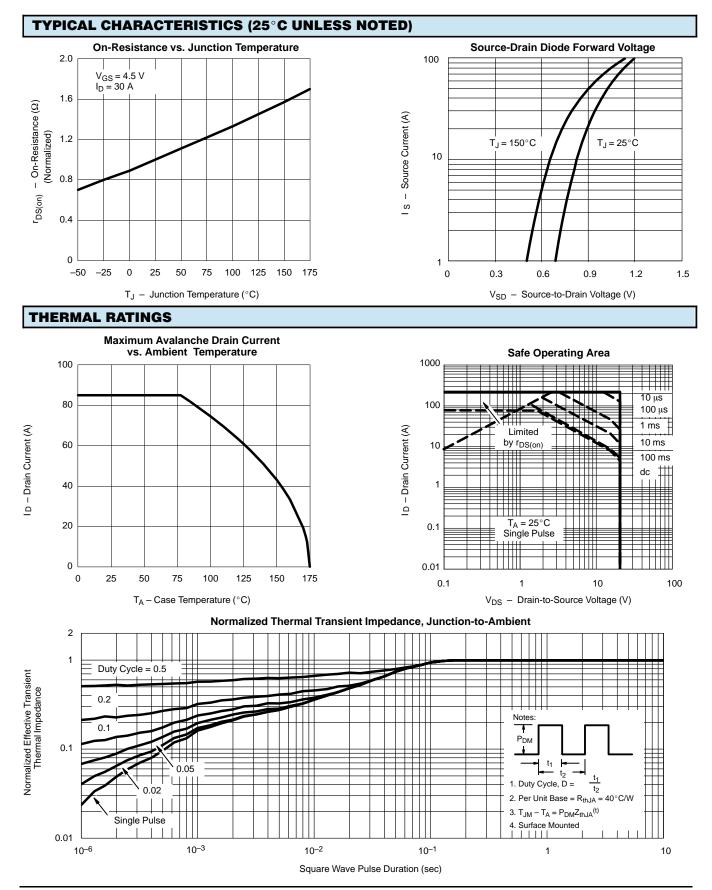


MOSFET SPECIFICATIO	$\mathbf{ONS} (\mathbf{T}_{\mathbf{J}} = 25^{\circ}\mathbf{C}$	UNLESS OTHERWISE NOTE	D)				
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static			•				
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	20			v	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{DS} = 250 \ \mu A$	0.5		1.5		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V},  V_{GS} = \pm 12 \text{ V}$			±100	nA	
		$V_{DS} = 20 V, V_{GS} = 0 V$			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C}$			50	μA	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175^{\circ}\text{C}$			150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}$ = 5 V, $V_{GS}$ = 4.5 V	120			Α	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.005			
		$V_{GS} = 4.5 \text{ V}, I_D = 30 \text{ A}, T_J = 125^{\circ}\text{C}$		0.008			
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 30 \text{ A}, T_J = 175^{\circ}\text{C}$		0.010		Ω	
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.005			
Forward Transconductancea	9 <sub>fs</sub>	$V_{DS} = 5 V, I_{D} = 30 A$	20			S	
Dynamic <sup>b</sup>	1 1		•	•		•	
Input Capacitance	C <sub>iss</sub>			2900			
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 20 V, f = 1 MHz		1100		pF	
Reversen Transfer Capacitance	C <sub>rss</sub>			600		1	
Total Gate Charge <sup>c</sup>	Qg			65	130		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 85 A		13		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			14		1	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			25	40		
Rise Time <sup>c</sup>	tr	$V_{DD}$ = 10 V, $R_L$ = 0.12 $\Omega$		120	180	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D\simeq 85$ A, $V_{GEN}$ = 4.5 V, $R_G$ = 2.5 $\Omega$		80	120	113	
Fall Time <sup>c</sup>	tf			100	150		
Source-Drain Diode Ratings a	nd Characteristic	s (T <sub>C</sub> = 25°C) <sup>b</sup>	-				
Pulsed Current	I <sub>SM</sub>				255	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{F} = 100 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.2	1.5	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 50 A, di/dt = 100 A/µs		45	100	ns	



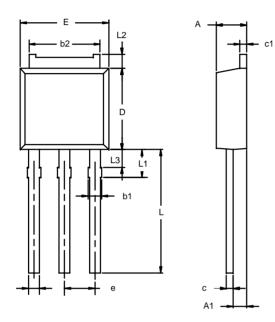








#### **TO**-251



Note: Dimension L3 is for reference only.

	MILLIMETERS		INCHES		
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090	BSC	
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	



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